TFT LCD Approval Specification

MODEL NO.: V315H3- LE1

Approved By	TV Product Marketing & Management Div	
	Chao-Chun Chung	

Reviewed By	QA Dept.	Product Development Div.
	Hsin-nan Chen	WT Lin

Prepared By	LCD TV Marketing and Product Management Div.	
	Vincent Chou	Hsin-Cheng Hung

CONTENTS -

1. GENERAL DESCRIPTION 5
1.1 OVERVIEW 5
1.2 FEATURES 5
1.3 APPLICATION 5
1.4 GENERAL SPECIFICATI0NS 5
1.5 MECHANICAL SPECIFICATIONS 5
2. ABSOLUTE MAXIMUM RATINGS 6
2.1 ABSOLUTE RATINGS OF ENVIRONMENT 6
2.2 ELECTRICAL ABSOLUTE RATINGS 6
2.2 PACKAGE STORGE 7
2.3 ELECTRICAL ABSOLUTE RATINGS 7
3. ELECTRICAL CHARACTERISTICS 8
3.1 TFT LCD MODULE 8
3.2 BACKLIGHT UNIT 11
4. BLOCK DIAGRAM OF INTERFACE 11
4.1 TFT LCD MODULE 11
5. INTERFACE PIN CONNECTION 12
5.1 TFT LCD MODULE 12
5.2 BACKLIGHT UNIT 14
5.3 BLOCK DIAGRAM OF INTERFACE 15
5.4 LVDS INTERFACE 17
5.5 COLOR DATA INPUT ASSIGNMENT 18
6. INTERFACE TIMING 19
6.1 INPUT SIGNAL TIMING SPECIFICATIONS 19
6.2 POWER ON/OFF SEQUENCE 22
7. OPTICAL CHARACTERISTICS 23
7.1 TEST CONDITIONS 23
7.2 OPTICAL SPECIFICATIONS 23
8. DEFINITION OF LABELS 27
8.1 CMO MODULE LABEL 27
9. PACKAGING 28
9.1 PACKING SPECIFICATIONS 28
9.2 PACKING METHOD 28
10. PRECAUTIONS 30
10.1 ASSEMBLY AND HANDLING PRECAUTIONS 30
10.2 SAFETY PRECAUTIONS 30
10.3 STORAGE PRECAUTIONS 30

11. REGULATORY STANDARDS 31
11.1 SAFETY 31
12. MECHANICAL CHARACTERISTIC 32

REVISION HISTORY

Version	Date	Page (New)	Section	Description
Ver 2.0	24,May 2010	All	All	Approval Specification was first issued.
Ver 2.1	7,Jun 2010	28	9.1 (3)	Weight : approximately 50Kg , corrected to 34 Kg (7 modules per box)
Ver 2.1	8,Jun 2010	12	5.1	Low (GND) or open for VESA, High (3.3V) for JEIDA, corrected to High (3.3V) or open for VESA, Low (GND) for JEIDA
Ver 2.1	8,Jun 2010	17	5.4	VESA LVDS format：(SELLVDS pin=L or open) corrected to VESA LVDS format：(SELLVDS pin=H or open) JEDIA LVDS format：(SELLVDS pin=H) corrected to JEDIA LVDS format：(SELLVDS pin=L)

1. GENERAL DESCRIPTION

1.1 OVERVIEW

V315H3- LE1 is a TFT Liquid Crystal Display module with LED Backlight unit and 2ch-LVDS interface. The display diagonal is 31.5”. This module supports 1920 x 1080 Full HDTV format and can display true 16.7M colors (8-bit/color).

1.2 FEATURES

- Optimized Brightness 400nits
- Contrast Ratio (4000:1)
- Fast Response Time (8.5 ms)
- Color Saturation NTSC 72%
- Full HDTV (1920 x 1080 pixels) resolution, true HDTV format
- DE (Data Enable) Only Mode
- LVDS (Low Voltage Differential Signaling) Interface
- Viewing Angle: 176(H)/176(V) (CR>20) MVA Technology
- Color Reproduction (Nature Color)

1.3 APPLICATION

-TFT LCD TVs

-Optimized Brightness, Multi-Media Displays

1.4 GENERAL SPECIFICATI0NS

Item	Specification	Unit	Note
Active Area	698.4(H) x 392.85(V))	mm	(1)
Bezel Opening Area	703.6(H) x 399 (V)	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920x R.G.B. x 1080	pixel	-
Pixel Pitch(Sub Pixel)	0.12125 (H) x 0.36375 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16.7M	color	-
Display Operation Mode	Transmissive mode / Normally Black	-	-
Surface Treatment	Anti-Glare coating (Haze 11%) Hard Coating (3H)	-	(2)

1.5 MECHANICAL SPECIFICATIONS

Item		Min.	Typ.	Max.	Unit	Note
Module Size Weight	Horizontal (H)	738.6	739.6	740.6	mm	Module Size
	Vertical (V)	439	440	441	mm	
	Depth (D)	9.8	10.8	11.8	mm	To Rear
		20.6	21.6	22.6	mm	To Boss
	Weight		4200		g	

Note (1)Please refer to the attached drawings for more information of front and back outline dimensions.

Note (2) Module Depth does not include connectors.

2. ABSOLUTE MAXIMUM RATINGS

2.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T_{ST}	-20	+60	ºC	(1)
Operating Ambient Temperature	T_{OP}	0	50	ºC	(1), (2)
Shock (Non-Operating)	S_{NOP}	-	50	G	(3), (5)
Vibration (Non-Operating)	V_{NOP}	-	1.0	G	(4), (5)

Note (1) Temperature and relative humidity range is shown in the figure below.

(a) 90 %RH Max. (Ta ≦ 40 ºC).

(b) Wet-bulb temperature should be 39 ºC Max. (Ta > 40 ºC).

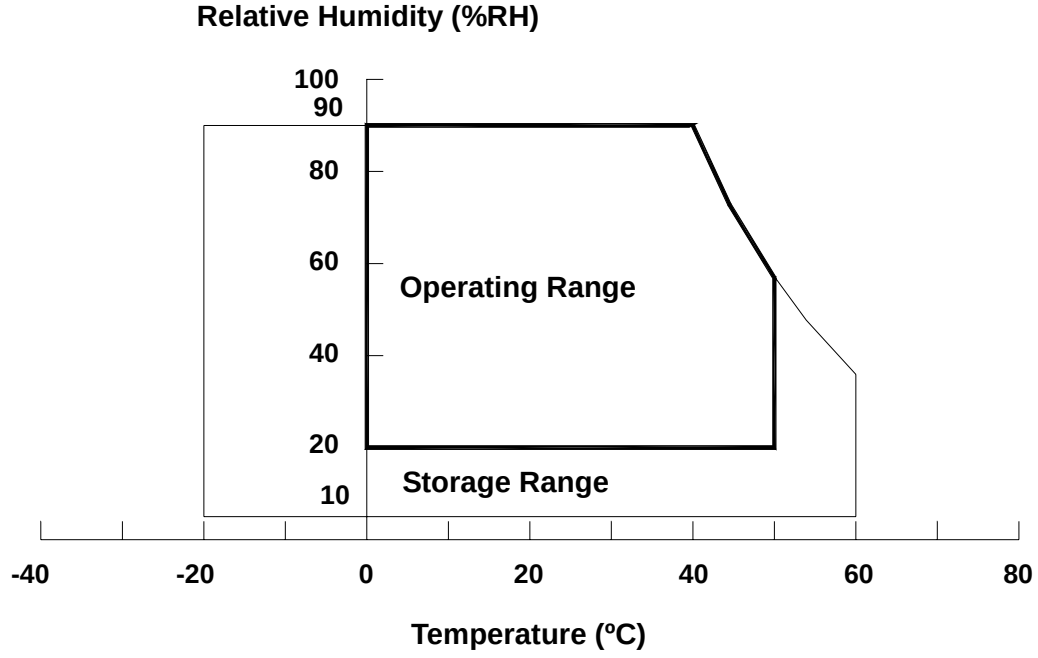
(c) No condensation.

Note (2) The maximum operating temperature is based on the test condition that the surface temperature of display area is less than or equal to 65 ºC with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 65 ºC. The range of operating temperature may degrade in case of improper thermal management in final product design.

Note (3) 11 ms, half sine wave, 1 time for ± X, ± Y, ± Z.

Note (4) 10 ~ 200 Hz, 30 min, 1 time each X, Y, Z.

Note (5) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



2.2 PACKAGE STORGE

When storing modules as spares for a long time, the following precaution is necessary.

(a) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35℃at normal humidity without condensation.

(b) The module shall be stored in dark place. Do not store the TFT-LCD module in direct sunlight or fluorescent light.

2.3 ELECTRICAL ABSOLUTE RATINGS

2.3.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	Vcc	-0.3	13.5	V	(1)
Input Signal Voltage	V_{IN}	-0.3	3.6	V	

2.3.2 BACKLIGHT UNIT

Item	Symbol	Test Condition	Min.	Type	Max.	Unit	Note
Light Bar Voltage	V_W	Ta = 25 ℃	-	-	140	V	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

3. ELECTRICAL CHARACTERISTICS

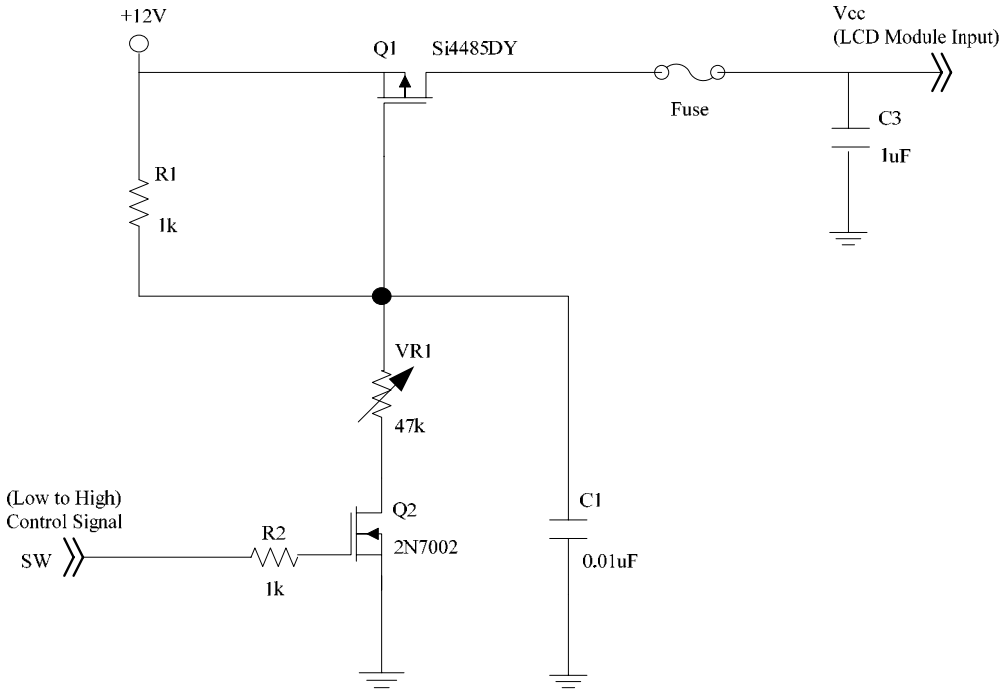
3.1 TFT LCD MODULE

(Ta = 25 ± 2 ºC)

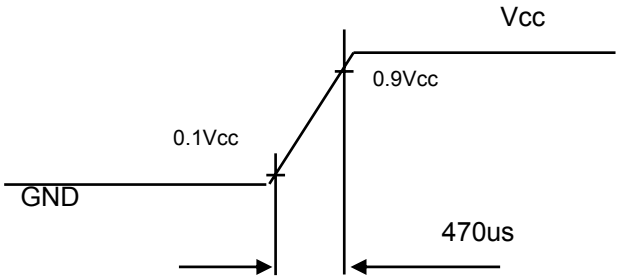
Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		V_{CC}	10.8	12	13.2	V	(1)
Rush Current		I_{RUSH}	—	—	1.81	A	(2)
Power Supply Current	White Pattern	—	—	0.63	—	A	(3)
	Black Pattern	—	—	0.38	—	A	
	Horizontal Stripe	—	—	0.82	0.99	A	
LVDS interface	Differential Input High Threshold Voltage	V_{LVTH}	+100	—	—	mV	(4)
	Differential Input Low Threshold Voltage	V_{LVTL}	—	—	-100	mV	
	Common Input Voltage	V_{CM}	1.0	1.2	1.4	V	
	Differential input voltage (Single-end)	$\|V_{ID}\|$	200	—	600	mV	
	Terminating Resistor	R_T	—	100	—	ohm	
CMOS interface	Input High Threshold Voltage	V_{IH}	2.7	—	3.3	V	
	Input Low Threshold Voltage	V_{IL}	0	—	0.7	V	

Note (1) The module should be always operated within above ranges.

Note (2) Measurement Conditions:



Vcc rising time is 470us



Note (3) The specified power supply current is under the conditions at Vcc = 12 V, Ta = 25 ± 2 ºC, f_v = 60 Hz, whereas a power dissipation check pattern below is displayed.

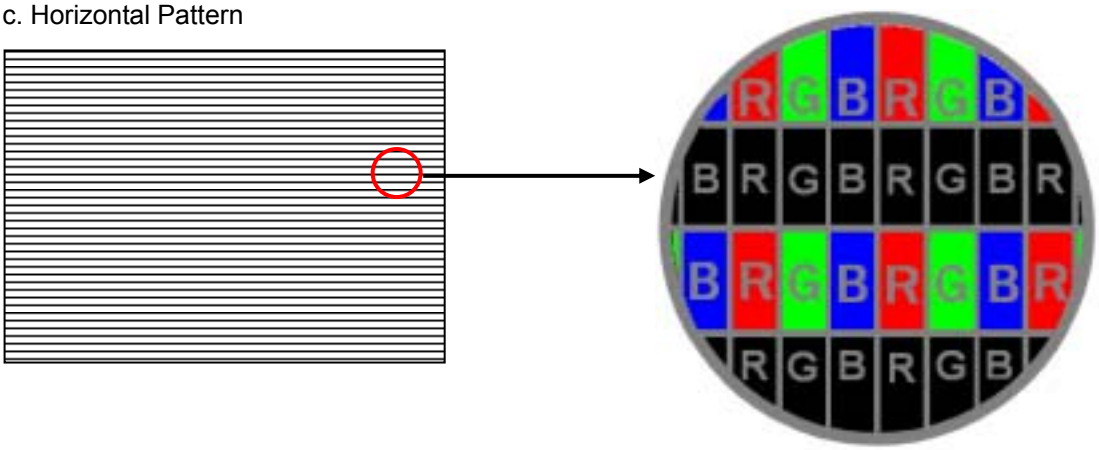
a. White Pattern

Active Area

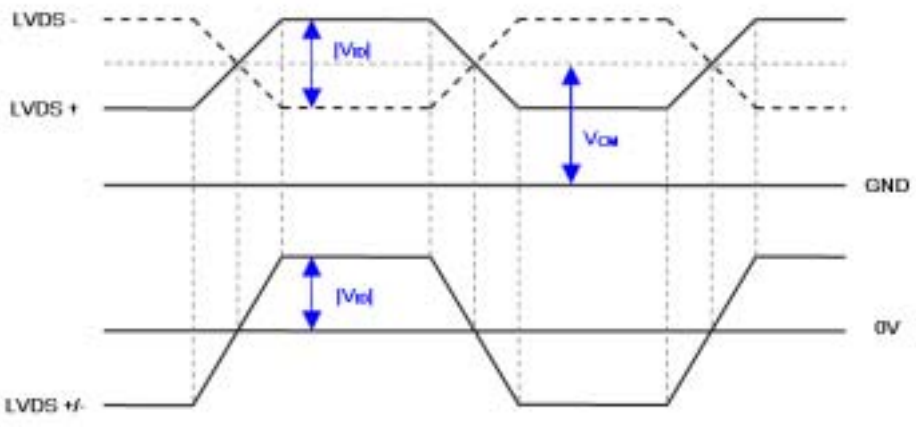
b. Black Pattern

Active Area

c. Horizontal Pattern



Note (4) The LVDS input characteristics are as follows:



3.2 BACKLIGHT UNIT

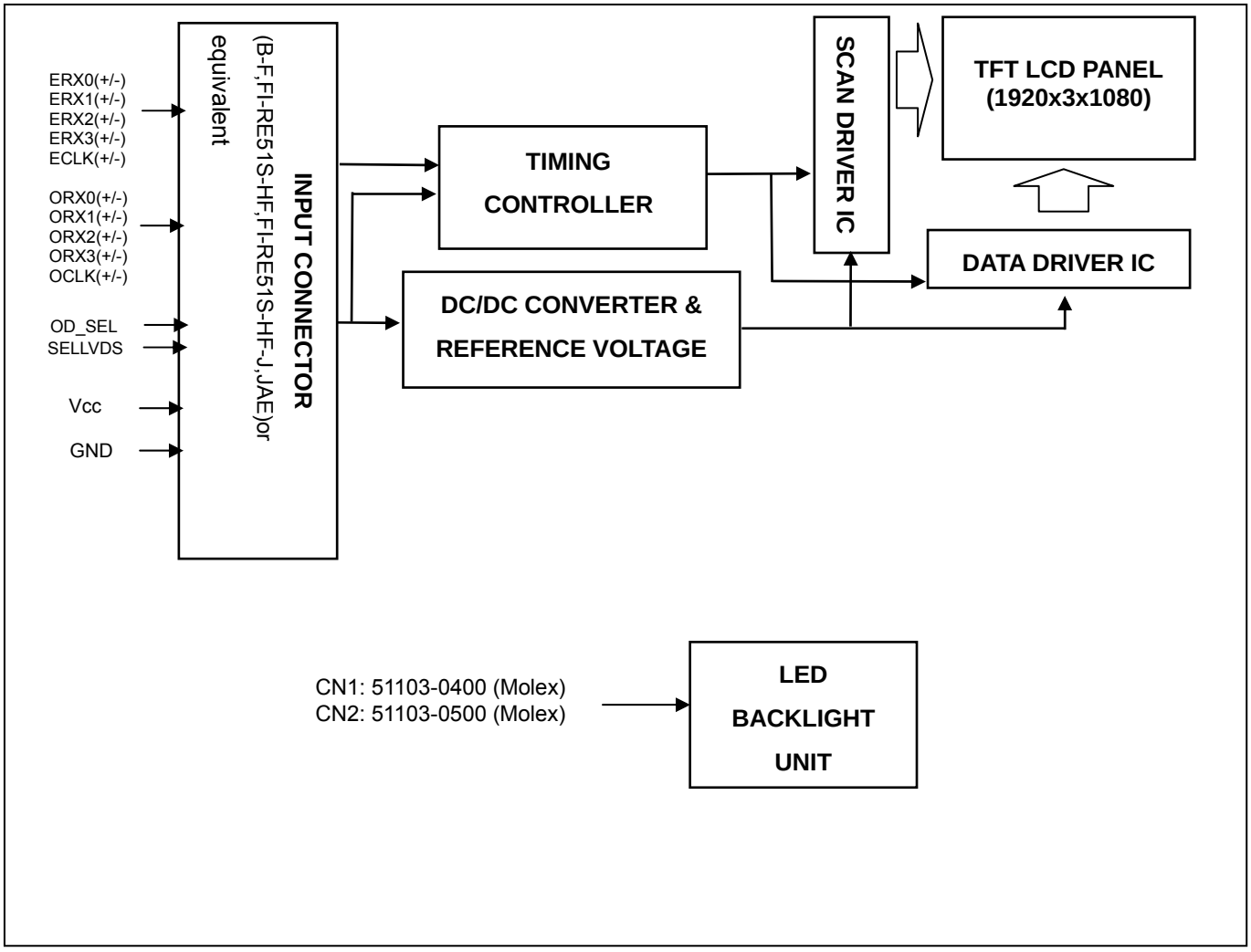
3.2.1 LED LIGHT BARCHARACTERISTICS (Ta = 25 ± 2 ºC)

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Light Bar Voltage	V_W	-	-	129.2	V	I_L =80mA
Forward Voltage	V_f	3.0	-	3.4	V	I_L =80mA
LED Current	I_L	75.2	80.0	84.8	mA	
Life time	-	30,000	-	-	Hrs	(1)

Note (1) The lifetime is defined as the time which luminance of the LED decays to 50% compared to the initial value, Operating condition: Continuous operating at Ta = 25±2℃, I_L =80mA

4. BLOCK DIAGRAM OF INTERFACE

4.1 TFT LCD MODULE



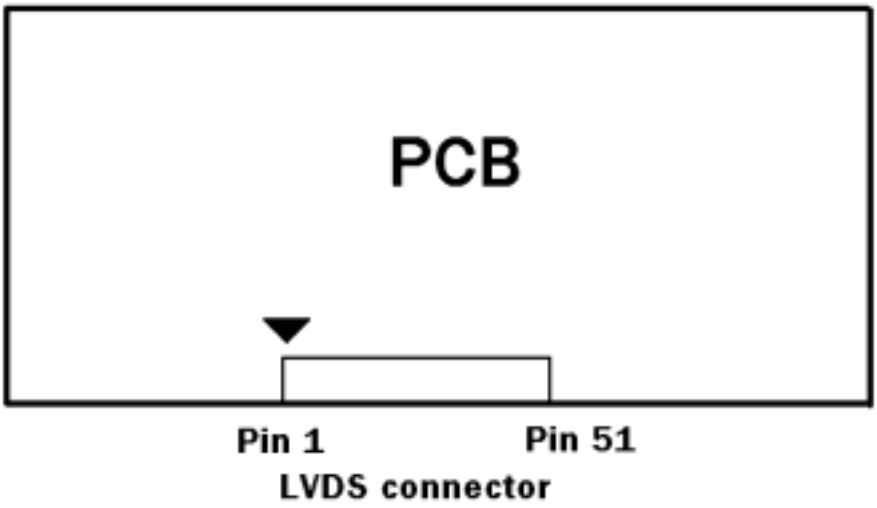
5. INTERFACE PIN CONNECTION

5.1 TFT LCD MODULE

CNF1 Connector Pin Assignment

Pin	Name	Description	Note
1	VCC	+12V power supply	
2	VCC	+12V power supply	
3	VCC	+12V power supply	
4	VCC	+12V power supply	
5	VCC	+12V power supply	
6	NC	No Connection	(2)
7	GND	Ground	
8	GND	Ground	
9	GND	Ground	
10	ORX0-	Odd pixel Negative LVDS differential data input. Channel 0	
11	ORX0+	Odd pixel Positive LVDS differential data input. Channel 0	
12	ORX1-	Odd pixel Negative LVDS differential data input. Channel 1	
13	ORX1+	Odd pixel Positive LVDS differential data input. Channel 1	
14	ORX2-	Odd pixel Negative LVDS differential data input. Channel 2	
15	ORX2+	Odd pixel Positive LVDS differential data input. Channel 2	
16	GND	Ground	
17	OCLK-	Odd pixel Negative LVDS differential clock input	
18	OCLK+	Odd pixel Positive LVDS differential clock input.	
19	GND	Ground	
20	ORX3-	Odd pixel Negative LVDS differential data input. Channel 3	
21	ORX3+	Odd pixel Positive LVDS differential data input. Channel 3	
22	NC	No Connection	(2)
23	NC	No Connection	
24	GND	Ground	
25	ERX0-	Even pixel Negative LVDS differential data input. Channel 0	
26	ERX0+	Even pixel Positive LVDS differential data input. Channel 0	
27	ERX1-	Even pixel Negative LVDS differential data input. Channel 1	
28	ERX1+	Even pixel Positive LVDS differential data input. Channel 1	
29	ERX2-	Even pixel Negative LVDS differential data input. Channel 2	
30	ERX2+	Even pixel Positive LVDS differential data input. Channel 2	
31	GND	Ground	
32	ECLK-	Even pixel Negative LVDS differential clock input.	
33	ECLK+	Even pixel Positive LVDS differential clock input.	
34	GND	Ground	
35	ERX3-	Even pixel Negative LVDS differential data input. Channel 3	
36	ERX3+	Even pixel Positive LVDS differential data input. Channel 3	
37	NC	No Connection	(2)
38	NC	No Connection	
39	GND	Ground	
40	SCL	EEPROM I2C serial clock	
41	SDA	EEPROM I2C serial data	
42	NC	No Connection	(2)
43	B_INT(WP)	Write protection	
44	PANEL_SEL	No Connection	(2)
45	SELLVDS	High (3.3V) or open for VESA, Low (GND) for JEIDA	
46	OD_SEL	Overdriving lookup table selection	(3)
47	NC	No Connection	(2)
48	NC	No Connection	
49	NC	No Connection	
50	TCON_RDY	T-CON ready signal	
51	NC	No Connection	(2)

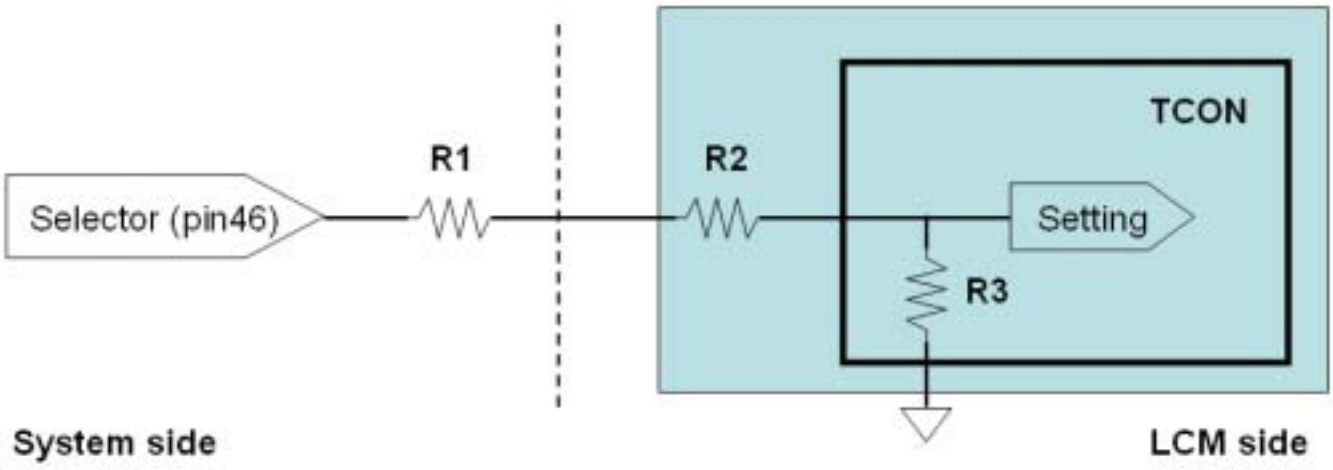
Note (1) LVDS connector pin order defined as follows



Note (2) Reserved for internal use. Please leave it open.

Note (3) ODSEL signal pin connected to the LCM side has the following diagram.

R1 in the system side should be less than 1K Ohm. (R1 < 1K Ohm)



Note (4) Two pixel data send into the module for every clock cycle. The first pixel of the frame is odd pixel and the second pixel is even pixel.

5.2 BACKLIGHT UNIT

The pin configuration for the housing and the leader wire is shown in the table below.

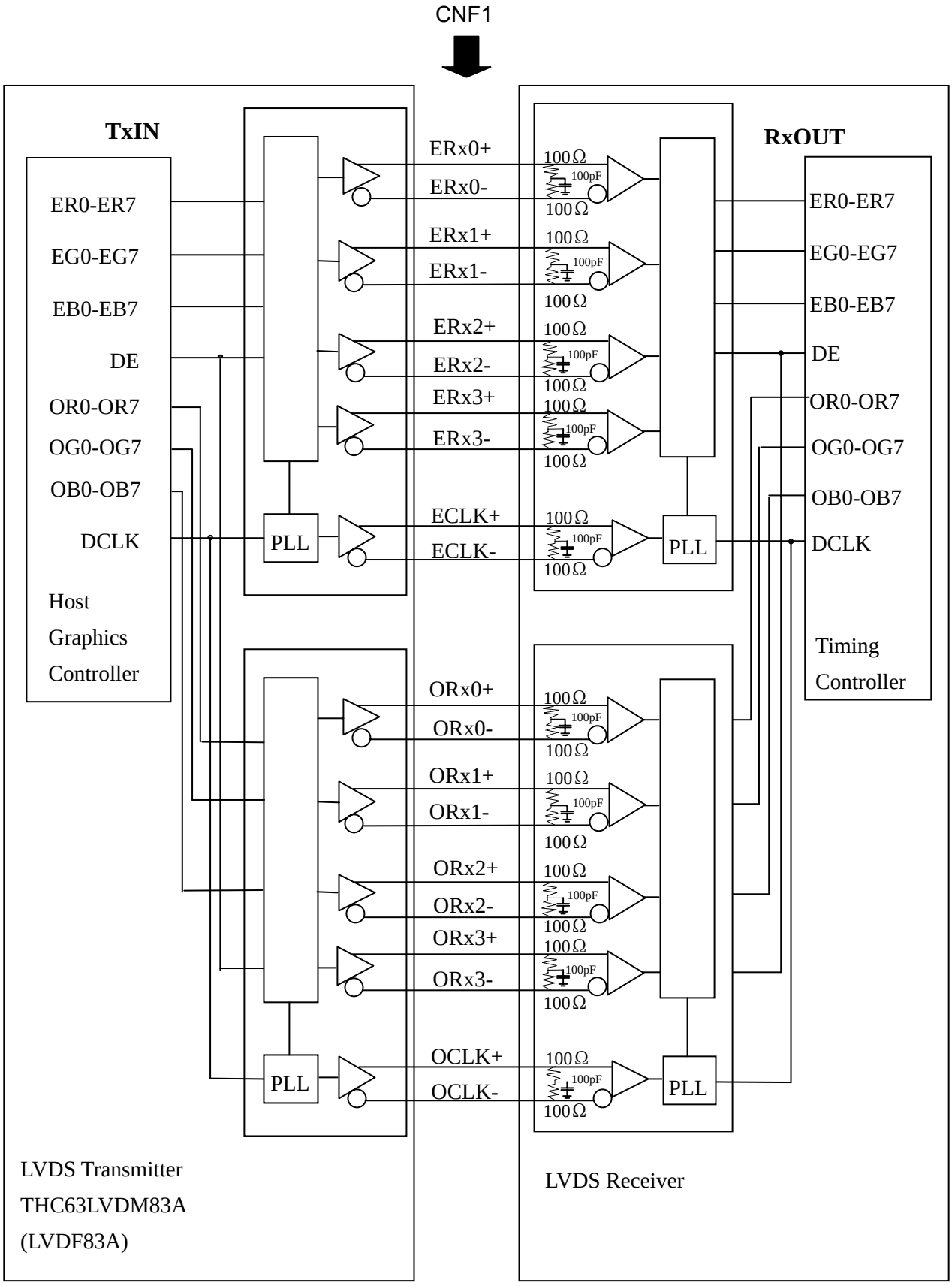
CN1: 51103-0400 (Molex)

Pin №	Symbol	Feature
1	+OUT1	Positive of LED String
2	+OUT2	
3	NC	NC
4	NC	

CN2: 51103-0500 (Molex)

Pin №	Symbol	Feature
1	-OUT1	Negative of LED String
2	-OUT2	
3	NC	NC
4	NC	
5	NC	

5.3 BLOCK DIAGRAM OF INTERFACE



ER0~ER7: Even pixel R data

EG0~EG7: Even pixel G data

EB0~EB7: Even pixel B data

OR0~OR7: Odd pixel R data

OG0~OG7: Odd pixel G data

OB0~OB7: Odd pixel B data

DE: Data enable signal

DCLK: Data clock signal

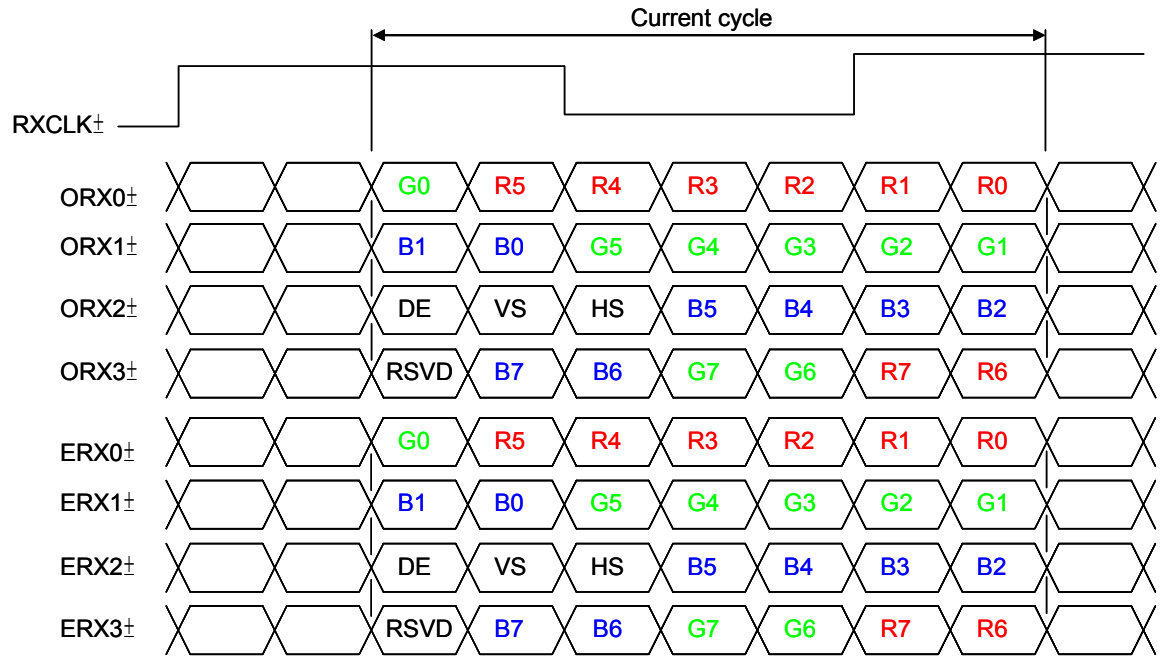
Note (1) The system must have the transmitter to drive the module.

Note (2) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line when it is used differentially.

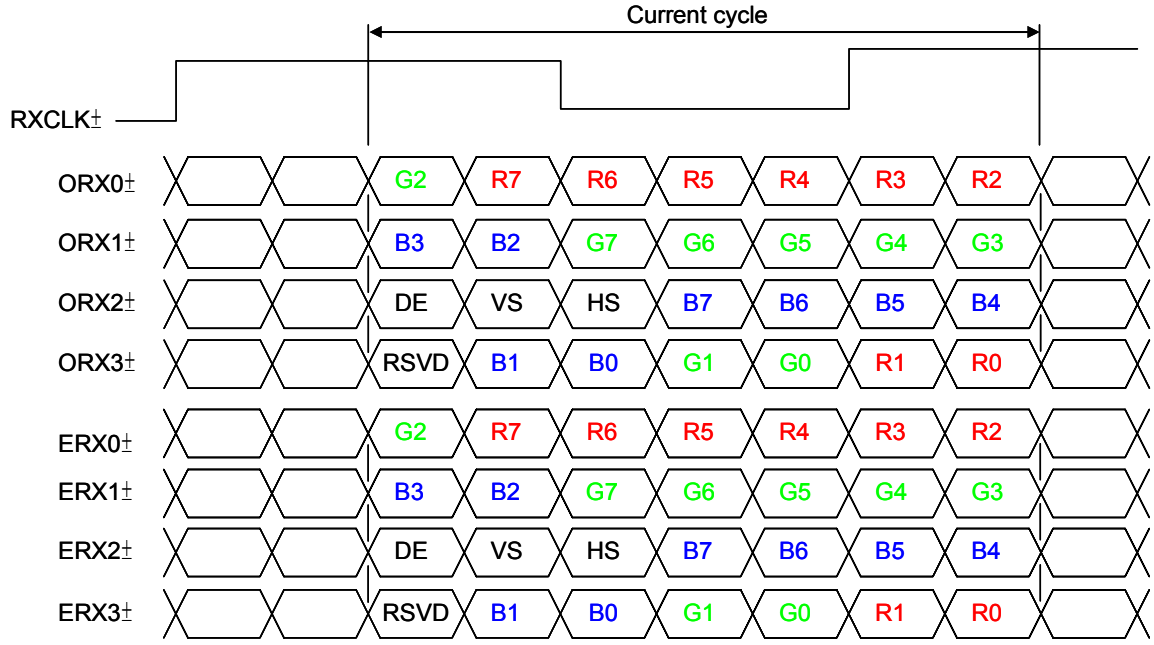
Note (3) Two pixel data send into the module for every clock cycle. The first pixel of the frame is odd pixel and the second pixel is even pixel.

5.4 LVDS INTERFACE

VESA LVDS format：(SELLVDS pin=H or open)



JEDIA LVDS format：(SELLVDS pin=L)



R0~R7: Pixel R Data (7; MSB, 0; LSB)

G0~G7: Pixel G Data (7; MSB, 0; LSB)

B0~B7: Pixel B Data (7; MSB, 0; LSB)

DE : Data enable signal

DCLK : Data clock signal

Notes: (1) RSVD (reserved) pins on the transmitter shall be “H” or “L”.

5.5 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of the color versus data input.

Color		Data Signal																							
		Red								Green								Blue							
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale Of Green	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Gray Scale Of Blue	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

6. INTERFACE TIMING

6.1 INPUT SIGNAL TIMING SPECIFICATIONS

(Ta = 25 ± 2 ºC)

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
LVDS Receiver Clock	Frequency	F_{clkin} (=1/TC)	60	74.25	80	MHz	
	Input cycle to cycle jitter	T_{rcl}	—	—	200	ps	(3)
	Spread spectrum modulation range	F_{clkin_mod}	F_{clkin}-2%	—	F_{clkin}+2%	MHz	(4)
	Spread spectrum modulation frequency	F_{SSM}	—	—	200	KHz	
LVDS Receiver Data	Setup Time	Tlvsu	600	—	—	ps	(5)
	Hold Time	Tlvhd	600	—	—	ps	
Vertical Active Display Term	Frame Rate	F_{r5}	47	50	53	Hz	(6)
		F_{r6}	57	60	63	Hz	
	Total	Tv	1115	1125	1480	Th	Tv=Tvd+Tvb
	Display	Tvd	1080	1080	1080	Th	—
	Blank	Tvb	35	45	55	Th	—
Horizontal Active Display Term	Total	Th	1050	1100	1225	Tc	Th=Thd+Thb
	Display	Thd	960	960	960	Tc	—
	Blank	Thb	90	140	190	Tc	—

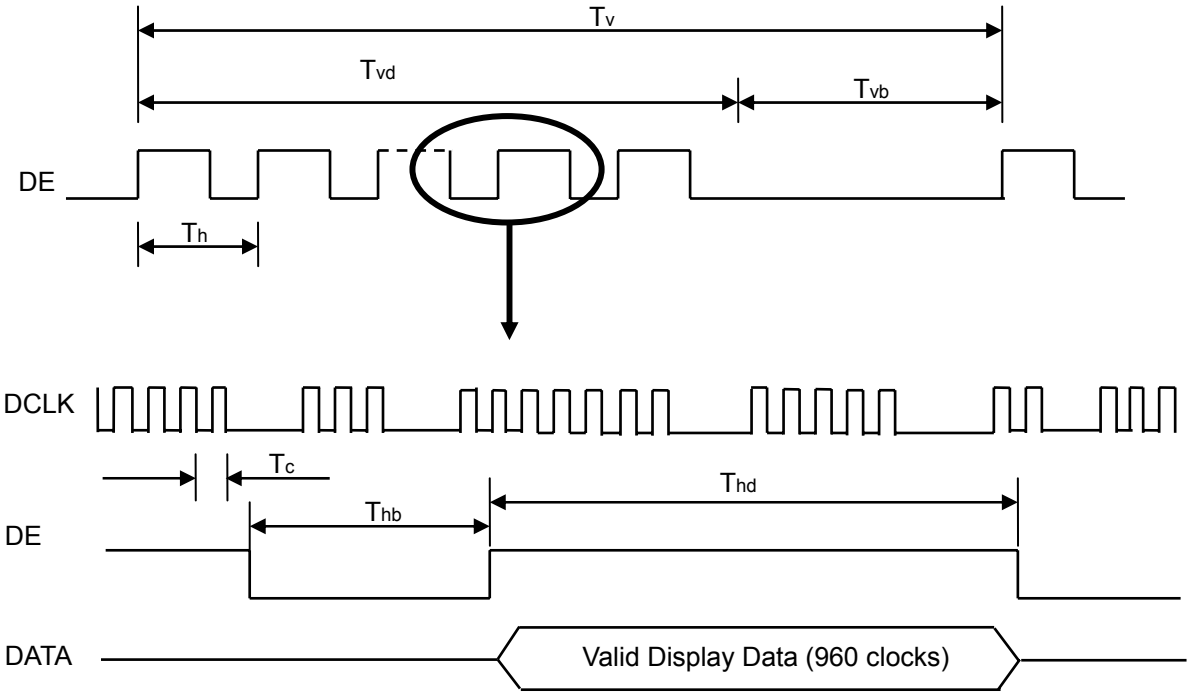
Note (1) Please make sure the range of pixel clock has follow the below equation：

Fclkin(max) ≧ Fr6 ╳ Tv ╳ Th

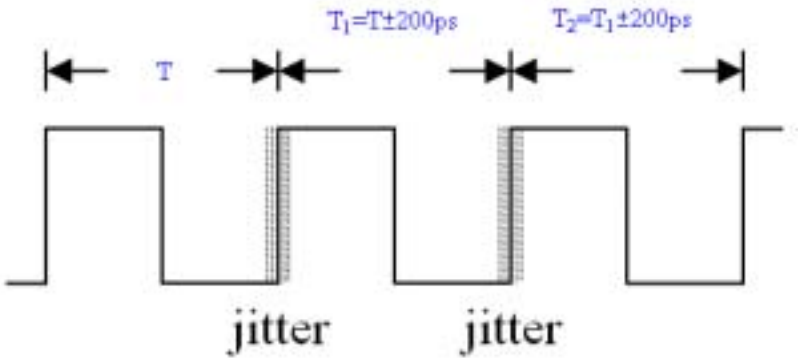
Fr5 ╳ Tv ╳ Th ≧ Fclkin(min)

Note (2) This module is operated in DE only mode and please follow the input signal timing diagram below：

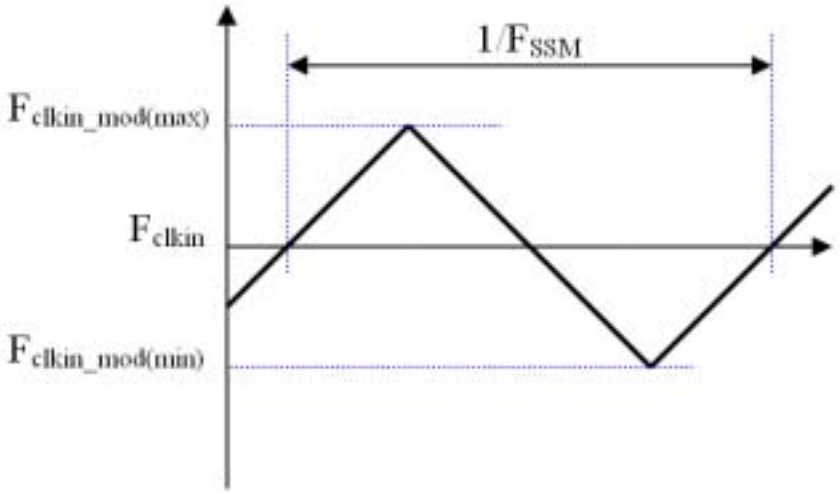
INPUT SIGNAL TIMING DIAGRAM



Note (3) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = I T_1 – TI

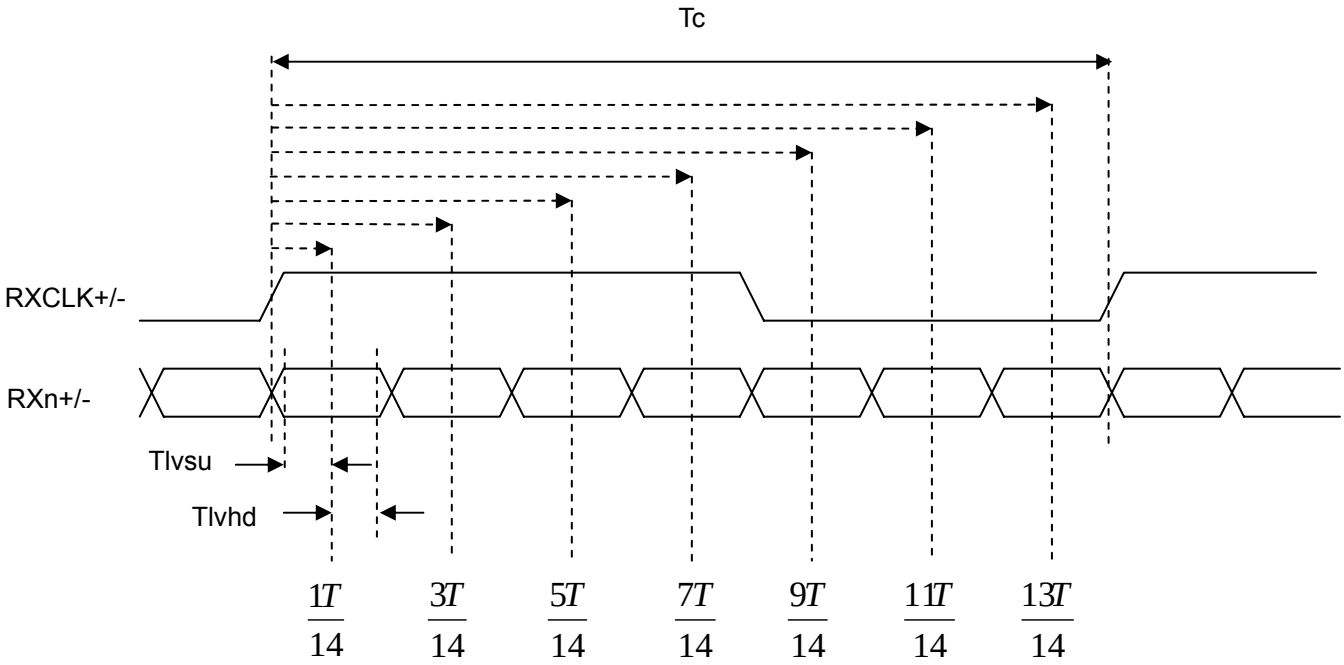


Note (4) The SSCG (Spread spectrum clock generator) is defined as below figures.



Note (5) The LVDS timing diagram and setup/hold time is defined and showing as the following figures.

LVDS RECEIVER INTERFACE TIMING DIAGRAM

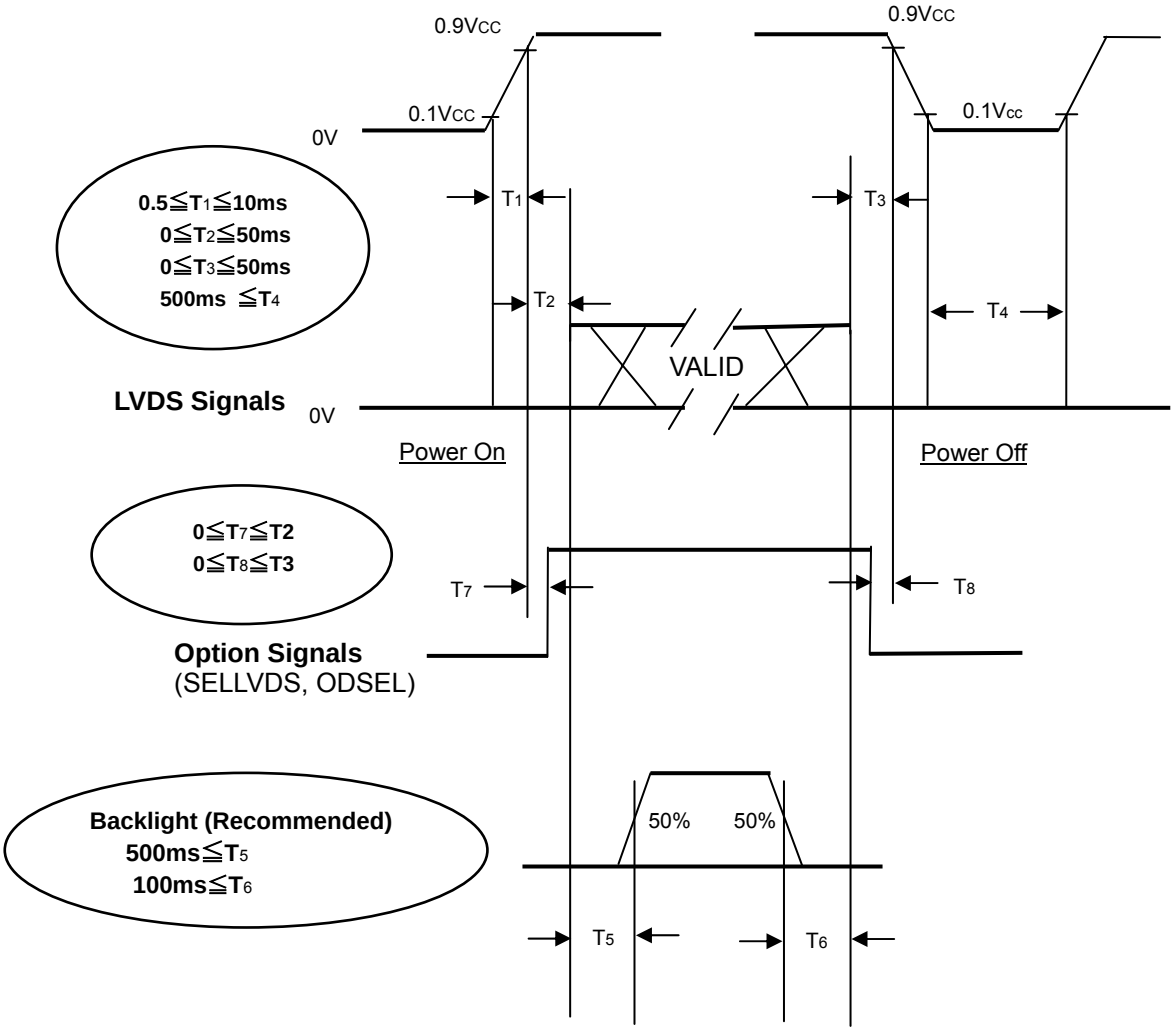


Note (6) (ODSEL) = H/L or open for 50/60Hz frame rate. Please refer to 5.1 for detail information

6.2 POWER ON/OFF SEQUENCE

(Ta = 25 ± 2 ºC)

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.



Power ON/OFF Sequence

Note (1) The supply voltage of the external system for the module input should follow the definition of Vcc.

Note (2) Apply the LED voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.

Note (3) In case of Vcc is in off level, please keep the level of input signals on the low or high impedance. If T2<0,that maybe cause electrical overstress failure.

Note (4) T4 should be measured after the module has been fully discharged between power off and on period.

Note (5) Interface signal shall not be kept at high impedance when the power is on.

7. OPTICAL CHARACTERISTICS

7.1 TEST CONDITIONS

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	V_{CC}	12V	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Current	I_L	80±4.8	mA

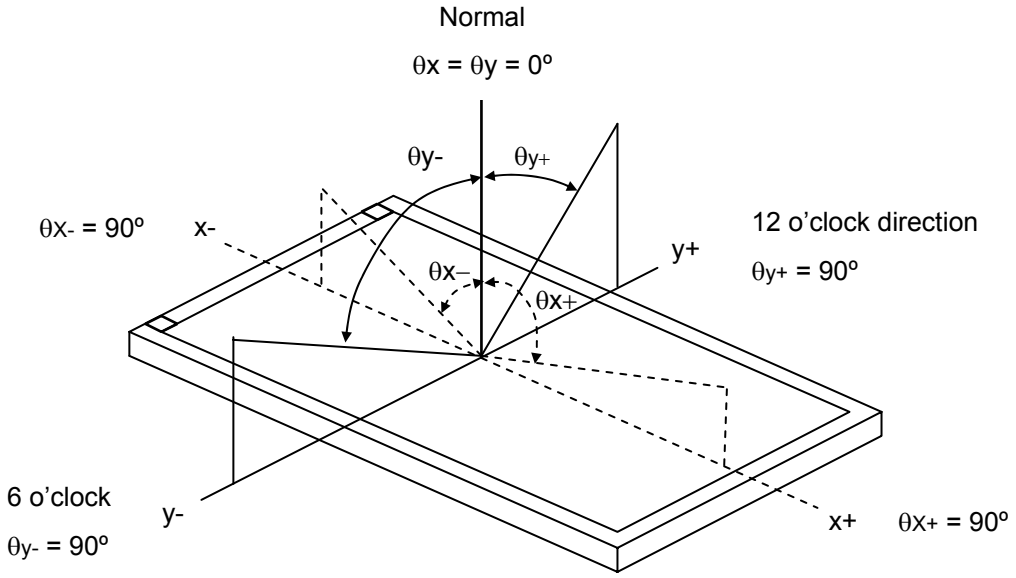
7.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 7.2. The following items should be measured under the test conditions described in 7.1 and stable environment shown in Note (6).

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio		CR	θ_x=0°, θ_Y =0° Viewing Angle at Normal Direction	(3000)	(4000)	-	-	(2)
Response Time		Gray to gray average		-	(8.5)	-	ms	(3)
Center Luminance of White		L_C		(300)	(400)	-	cd/m^2	(4)
White Variation		δW		-	-	1.3	-	(7)
Cross Talk		CT		-	-	4.0	%	(5)
Color Chromaticity	Red	Rx		Typ -0.03	(0.623)	Typ +0.03	-	(6)
		Ry			(0.326)		-	
	Green	Gx			(0.312)		-	
		Gy			(0.626)		-	
	Blue	Bx			(0.155)		-	
		By			(0.044)		-	
	White	Wx			(0.280)		-	
		Wy			(0.290)		-	
	Color Gamut	CG		-	(72)	-	%	NTSC
Viewing Angle	Horizontal	θ_x+	CR≥20	80	88	-	Deg.	(1)
		θ_x-		80	88	-		
	Vertical	θ_Y+		80	88	-		
		θ_Y-		80	88	-		

Note (1) Definition of Viewing Angle (θx, θy):

Viewing angles are measured by Autronic Conoscope Cono-80



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

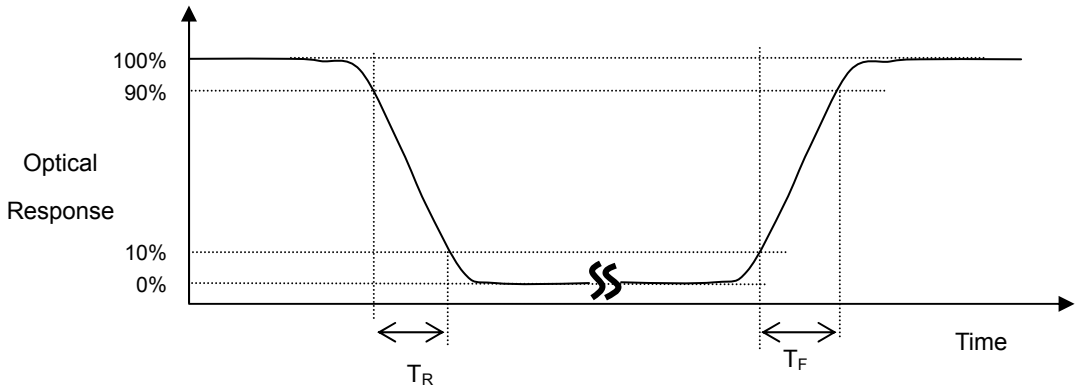
Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255

L 0: Luminance of gray level 0

CR = CR (5), where CR (X) is corresponding to the Contrast Ratio of the point X at the figure in Note (7)

Note (3) Definition of Response Time (Gray to Gray switching time):



The driving signal means the signal of Gray 0, 31, 63, 95, 127,159, 191, 223, 255. Gray to gray average time means the average switching time of gray 0, 31, 63, 95, 127,159, 191, 223, 255 to each other.

Note (4) Definition of Luminance of White (L_C):

Measure the luminance of gray level 255 at center point.

L_C = L (5), where L (x) is corresponding to the luminance of the point X at the figure in Note (7).

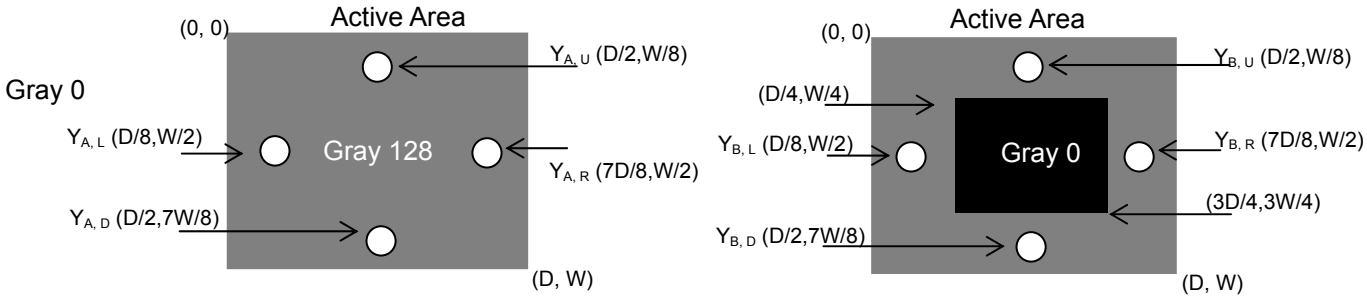
Note (5) Definition of Cross Talk (CT):

$CT = | Y_B – Y_A | / Y_A \times 100\ (\%)$

Where:

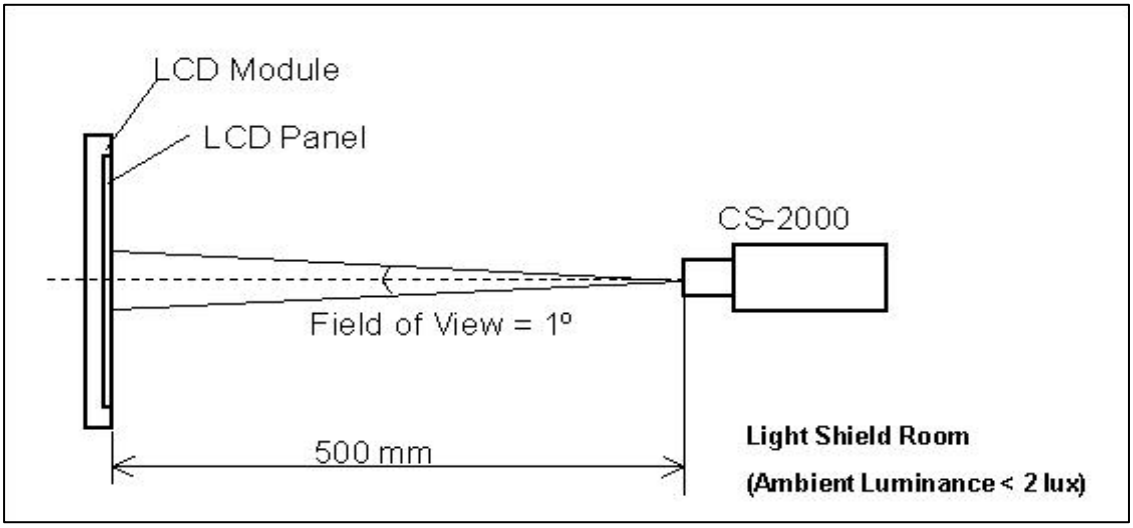
Y_A = Luminance of measured location without gray level 0 pattern (cd/m^2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m^2)



Note (6) Measurement Setup:

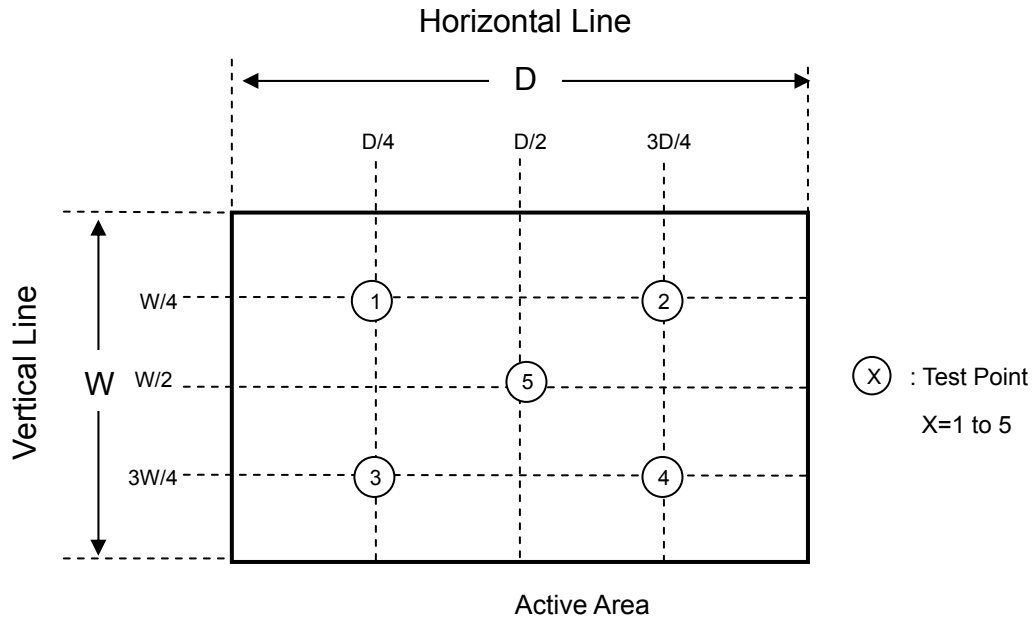
The LCD module should be stabilized at given temperature for 1 hour to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 1 hour in a windless room.



Note (7) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 5 points

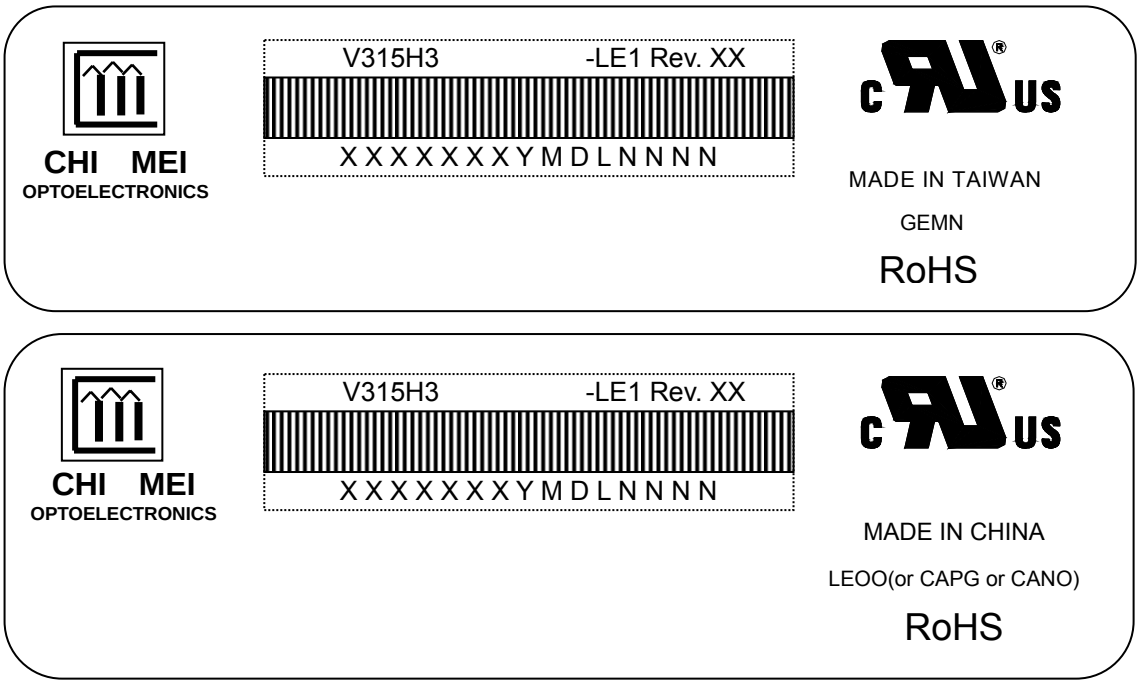
δW = Maximum [L (1), L (2), L (3), L (4), L (5)] / Minimum [L (1), L (2), L (3), L (4), L (5)]



8. DEFINITION OF LABELS

8.1 CMO MODULE LABEL

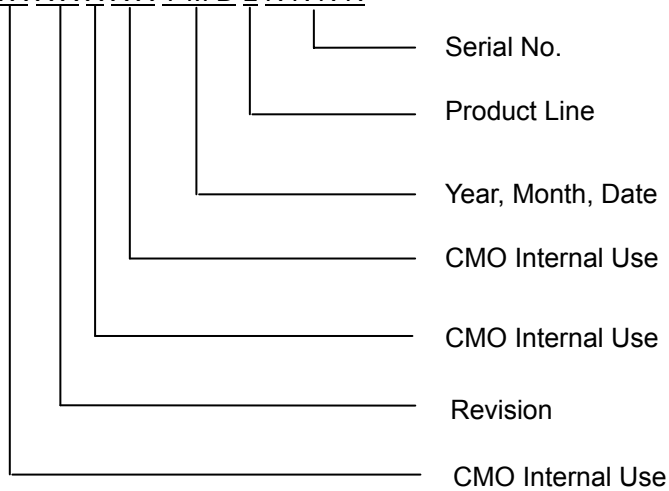
The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: V315H3-LE1

(b) Revision: Rev. XX, for example: A0, A1… B1, B2… or C1, C2…etc.

(c) Serial ID: X X X X X X X Y M D L N N N N



Serial ID includes the information as below:

(a) Manufactured Date: Year: 0~9, for 2010~2019

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I ,O, and U.

(b) Revision Code: Cover all the change

(c) Serial No.: Manufacturing sequence of product

(d) Product Line: 1 -> Line1, 2 -> Line 2, …etc.

9. PACKAGING

9.1 PACKING SPECIFICATIONS

(1) 7 LCD TV modules / 1 Box

(2) Box dimensions : 826(L)x376(W)x540(H)mm

(3) Weight : approximately 34 Kg (7 modules per box)

9.2 PACKING METHOD

Figures 9-1 and 9-2 are the packing method

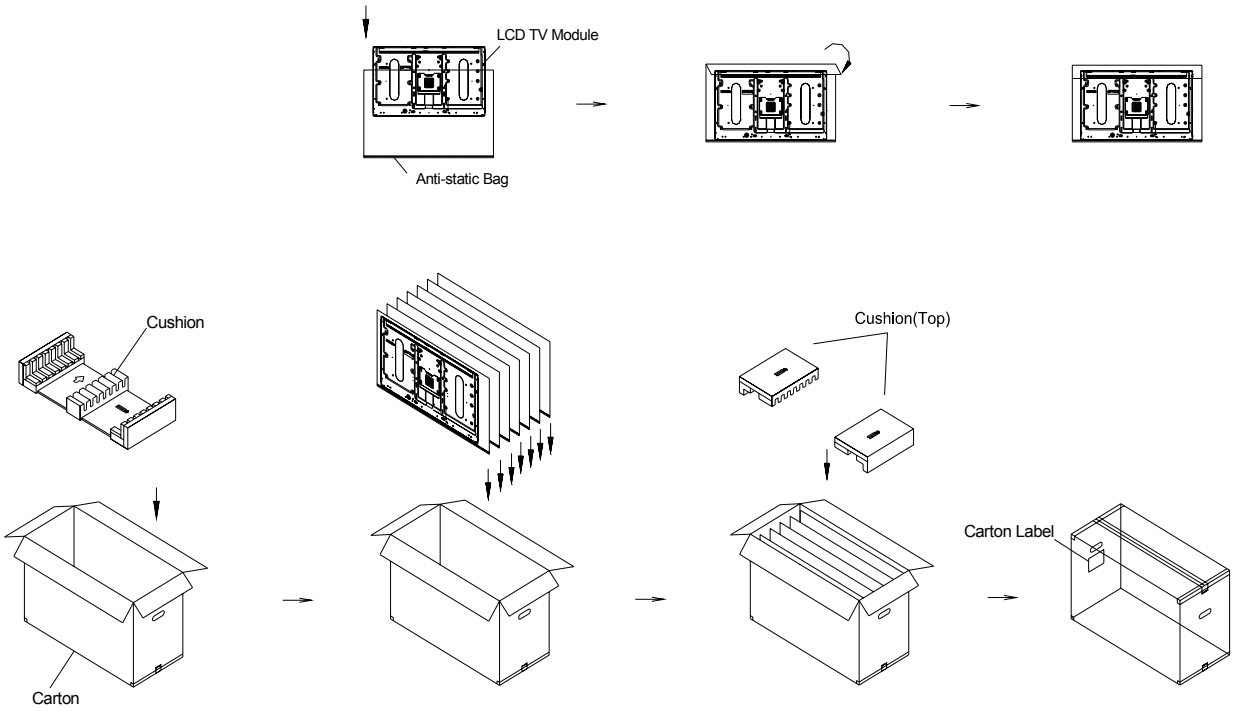
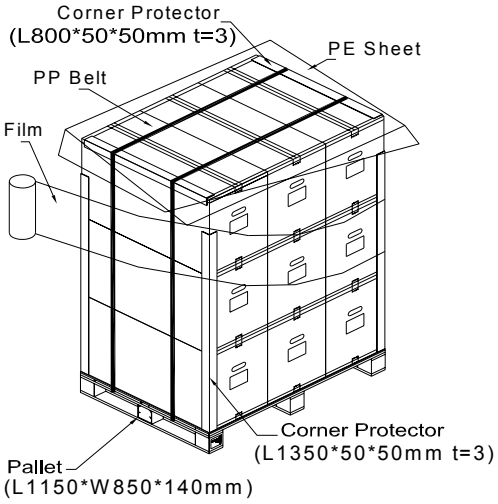
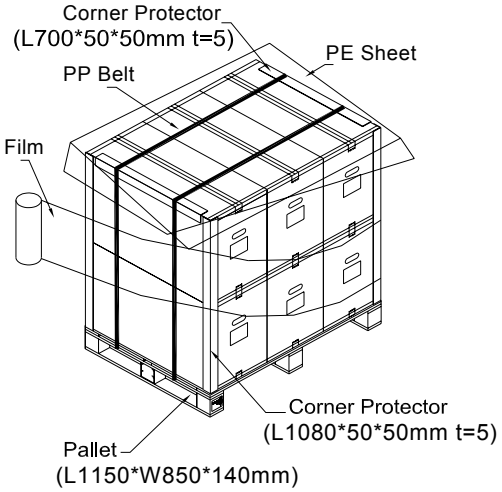


Figure.9-1 packing method

Sea / Land Transportation
(40ft Container)



Air Transportation



Sea / Land Transportation
(40ft HQ Container)

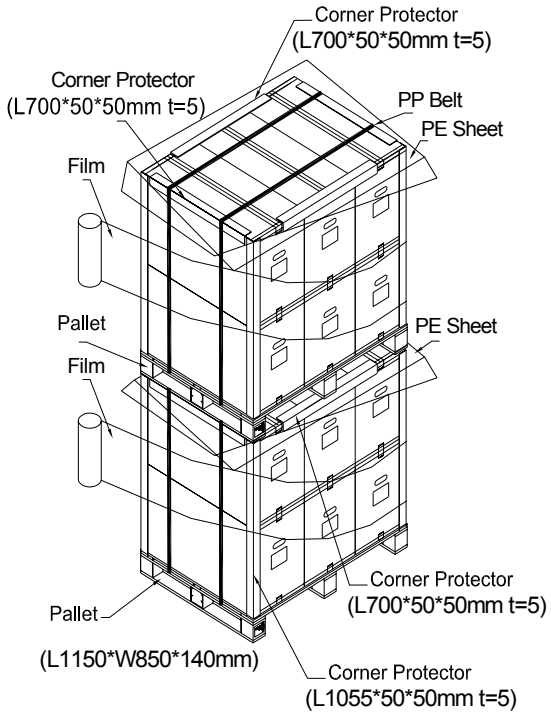


Figure. 9-2 Packing method

10. PRECAUTIONS

10.1 ASSEMBLY AND HANDLING PRECAUTIONS

(1) Do not apply rough force such as bending or twisting to the module during assembly.

(2) It is recommended to assemble or to install a module into the user's system in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.

(3) Do not apply pressure or impulse to the module to prevent the damage of LCD panel and backlight.

(4) Always follow the correct power-on sequence when the LCD module is turned on. This can prevent the damage and latch-up of the CMOS LSI chips.

(5) Do not plug in or pull out the I/F connector while the module is in operation.

(6) Do not disassemble the module.

(7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.

(8) Moisture can easily penetrate into LCD module and may cause the damage during operation.

(9) High temperature or humidity may deteriorate the performance of LCD module. Please store LCD modules in the specified storage conditions.

(10) When ambient temperature is lower than 10ºC, the display quality might be reduced. For example, the response time will become slow.

10.2 SAFETY PRECAUTIONS

(1) The startup voltage of a backlight is over 1000 Volts. It may cause an electrical shock while assembling with the inverter. Do not disassemble the module or insert anything into the backlight unit.

(2) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.

(3) After the module's end of life, it is not harmful in case of normal operation and storage.

10.3 STORAGE PRECAUTIONS

When storing modules as spares for a long time, the following precaution is necessary.

(1) Do not leave the module in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35°C at normal humidity without condensation.

(2) The module shall be stored in dark place. Do not store the TFT-LCD module in direct sunlight or fluorescent light.

11. REGULATORY STANDARDS

11.1 SAFETY

The LCD module should be certified with safety regulations as follows:

Requirement	Standard	Remark
UL	UL60950-1:2006 or Ed.2:2007	
	UL60065 Ed.7:2007	
cUL/CSA	CAN/CSA C22.2 No.60950-1-03 or 60950-1-07	
	CAN/CSA C22.2 No.60065-03:2006 + A1:2006	
CB	IEC60950-1:2005 / EN60950-1:2006+ A11:2009	
	IEC60065:2001+ A1:2005 / EN60065:2002 + A1:2006 + A11:2008	

12. MECHANICAL CHARACTERISTIC